

MODEL NO. : <u>TM017FDH02</u>

ISSUED DATE: <u>2009-06-02</u>

VERSION : Ver 2.0

□Preliminary Specification
■Final Product Specification

Customer:								
Approved by	Notes							

**SHANGHAI TIANMA Confirmed:** 

Prepared by	Checked by	Approved by
FE FR Z		MA. B. 6.3

This technical specification is subjected to change without notice







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## **Record of Revision**

Rev	Issued Date	Description	Editor
1.0	2009-05-22	Preliminary Specification Release	ZhenYing Zhang
2.0	2009-06-02	Final Specification	ZhenYing Zhang



### 1 General Specifications

	Feature	Spec	
	Size	1.77 inch	
	Resolution	128(RGB) x 160	
	Interface	CPU 8bits	
	Color Depth	65/262K	
	Technology Type	a-Si	
Display Spec.	Pixel Pitch (mm)	0.219x0.219	
	Pixel Configuration	R.G.B. Vertical Stripe	
	Display Mode	TM with Normally White	
	Surface Treatment(Up Polarizer)	Clear Type(3H)	
	Viewing Direction	6 o'clock	
	Gray Scale Inversion Direction	12 o'clock	
	LCM (W x H x D) (mm)	34.0x47.0x2.4	
Manhaniaal	Active Area(mm)	28.032x35.04	
Mechanical Characteristics	With/Without TSP	Without TSP	
Gilaraotoriotios	Weight (g)	6.2	
	LED Numbers	2 LEDs	
Electronic	Driver IC	HX8353-C	

Note 1: Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2: Requirements on Environmental Protection: RoHS

Note 3: LCM weight tolerance: +/- 5%



### 2 Input/Output Terminals

#### 2.1 TFT LCD Panel

No	Symbol	I/O	Description	Comment
1	LED1+	Р	LED anode	
2	LED2+	Р	LED anode	
3	LED-	Р	LED cathode	
4	NC	-	No Connection	
5	NRES	Ι	Reset Pin	
6	D15	Ι	Data input	
7	D14	Ι	Data input	
8	D13	Ι	Data input	
9	D12	I	Data input	
10	D11	I	Data input	
11	D10	I	Data input	
12	D9	I	Data input	
13	D8	I	Data input	
14	NC	-	No Connection	
15	NC	1	No Connection	
16	NC	1	No Connection	
17	NC	-	No Connection	
18	NC	-	No Connection	
19	NC	-	No Connection	
20	NC	-	No Connection	
21	NC	-	No Connection	
22	NRD	_	Read strobe	
23	NWR	Ι	Write strobe	
24	RS	Ι	Register select	
25	NCS	Ι	Chip select	
26	ID	0	ID Pin	
27	VCI	Р	Power supply	
28	GND	Р	Ground	
29	XR	Р	Touch panel coordinate in the right side of envisage drawing	
30	YD	Р	Touch panel coordinate in the down side of envisage drawing	
31	XL	Р	Touch panel coordinate in the left side of envisage drawing	
32	YU	Р	Touch panel coordinate in the up side of envisage drawing	
33	GND	Р	Power Supply of I/O Interface	

Note2-1: I/O definition:

I-----Input O---Output P----Power/Ground



## 3 Absolute Maximum Ratings

#### 3.1 Driving TFT LCD Panel

GND=0V,Ta = 25°C

Item	Symbol	Min	Max	Unit	Remark
Logic Supply Voltage	VCI	-0.3	3.7	V	
Analog Supply Voltage	VCI	-0.3	3.7	V	
Input Voltage	D15~D8,NCS,RS,NWR,NRD NRES	-0.3	VCI+0.3	٧	
Back Light Forward Current	$I_{LED}$		20	mA	For each LED
Operating Temperature	$T_{OPR}$	-20	70	$^{\circ}$	
Storage Temperature	$T_{STG}$	-30	80	$^{\circ}$	

### 4 Electrical Characteristics

### 4.1 Driving TFT LCD Panel

GND=0V, Ta=25℃

Item		Symbol	Min	Тур	Max	Unit	Remark
Logic Supply V	/oltage	VCI	2.3	2.8	3.3	V	
Analog Supply	Voltage	VCI	2.3	2.8	3.3	٧	
Input Signal	Low Level	VIL	-0.3		0.2xVCI	٧	D15~D8,NCS,RS,NWR,NRD
Voltage	High Level	VIH	0.8xVCI	1	VCI	V	NRES
Output Signal	Low Level	Vol		I	0.2xVCI	٧	ID
Voltage	High Level	Vон	0.8xVCI	I	VCI	٧	iD
		Black Mode (60Hz)		TBD		-	
(Panel+ LSI) Power Consumption		Standby Mode	-	TBD			
		Sleeping Mode		TBD			



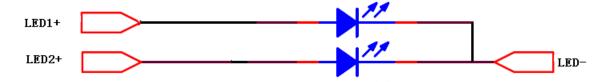
TM017FDH02 V2.0

#### 4.2 Driving Backlight

Ta=25°C

Item	Symbol	Min	Тур	Max	Unit	Remark
Forward Current	I <sub>F</sub>		15		mA	
Forward Current Voltage	$V_{F}$		3.2		V	
Backlight Power	$W_{BL}$		96		mW	
Consumption						

Note 1: The figure below shows the connection of backlight LED.

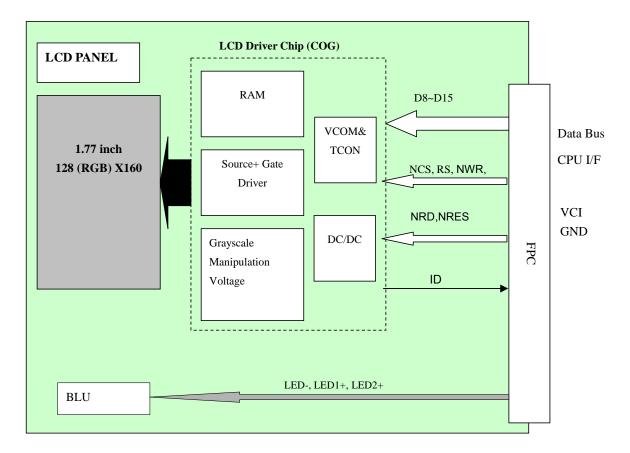


Note 2: One LED :  $I_F = 15$  mA,  $V_F = 3.2V$ 

Note 3: The Life of LED: 20,000 hours



#### 4.3 Block Diagram



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## **Timing Chart**

#### 5.1 **Timing Parameter**

Signal	Symbol	Parameter	Min.	Max.	Unit	Description	
RS	tast	Address setup time	0	-	ns		
KS	taht	Address hold time (Write/Read)	10	- ns -			
	tcнw	Chip select "H" pulse width	0	-			
	tcs	Chip select setup time (Write)	15	-			
NCS	trcs	Chip select setup time (Read ID)	45	-	ns	-	
	trosem	Chip select setup time (Read FM)	355	-			
	tose	Chip select wait time (Write/Read)	10	-			
	twc	Write cycle	66	-		-	
NWR	twen	Control pulse "H" duration	15	-	ns		
	twrL	Control pulse "L" duration	15	-			
	trc	Read cycle (ID)	160	-			
NRD	trон	Control pulse "H" duration (ID)	90	-	ns	When read ID data	
	trol	Control pulse "L" duration (ID)	45	-			
	trcfm	Read cycle (FM)	450	-		When read from frame	
NRD_E (FM)	trohem	Control pulse "H" duration (FM)	90	-	ns	memory	
	trolfm	Control pulse "L" duration (FM)	355	-		memory	
	tost	Data setup time	10	-			
	tont	Data hold time	10	-		For maximum CL=30pF	
DB15 to DB8	trat	Read access time (ID)	-	40	ns	For minimum CL=8pF	
	tratem	Read access time (FM)	-	340		r or minimum oc-opr	
	tорн	Output disable time	20	80			

Table 5.1 timing parameter

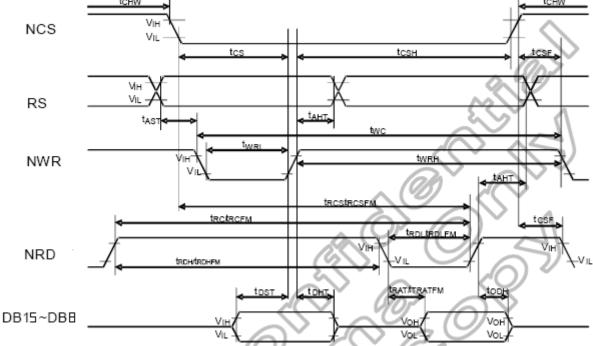
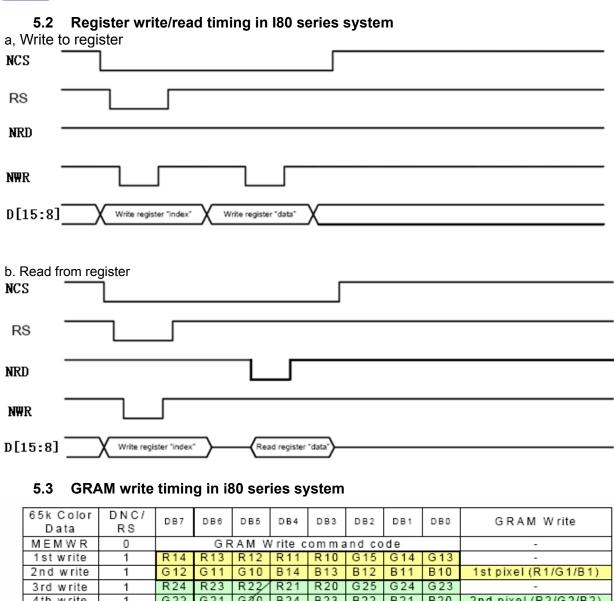


Figure 5.1 i80 System Bus Timing





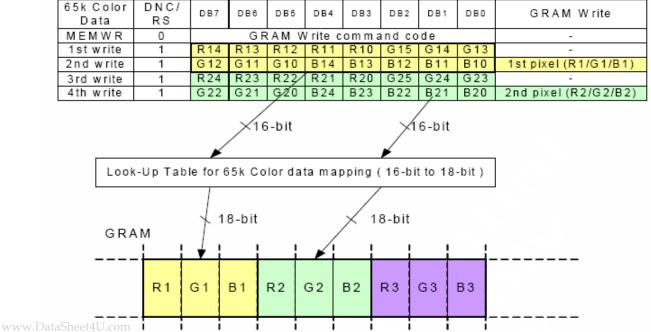
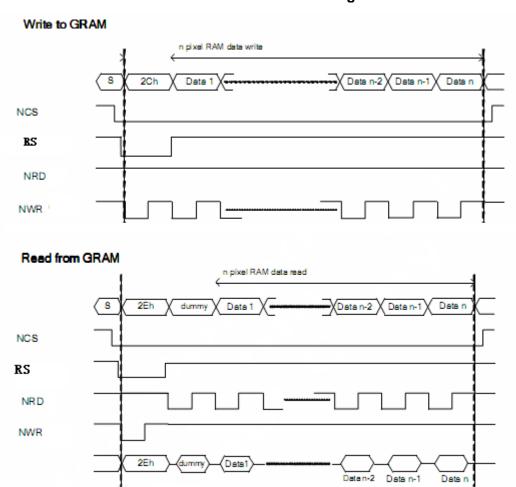


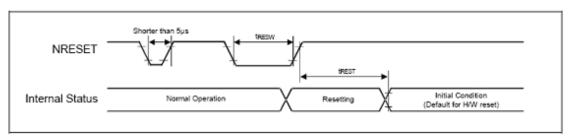
Table 5.3 GRAM Data and display data of 8- bit(65K Color) system interface

#### **GRAM Read/Write Timing**



#### 5.4 Reset Timing Characteristics

Ta=25℃



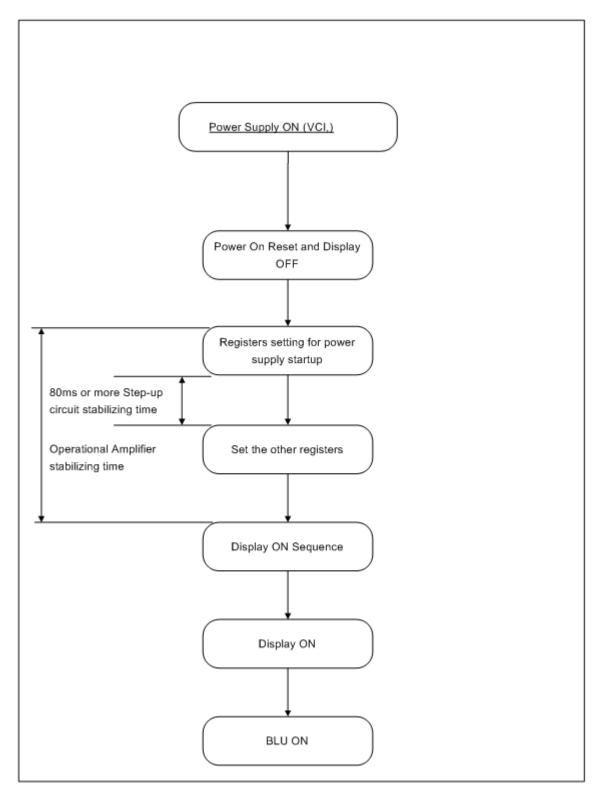
**Reset Input Timing** 

Symbol	Parameter	Related Pins	Spec.			Note	Unit
Symbol	Farameter	Related Fills	Min.	Typ.	Max.	Note	Ollic
tresw	Reset low pulse width <sup>(1)</sup>	NRESET	10	-	-	-	μs
trest	Reset complete time <sup>(2)</sup>	-	-	-	5	When reset applied during Sleep In mode	ms
		-		-	120	When reset applied during Sleep Out mode	ms

Figure 5.4 NRES Timing

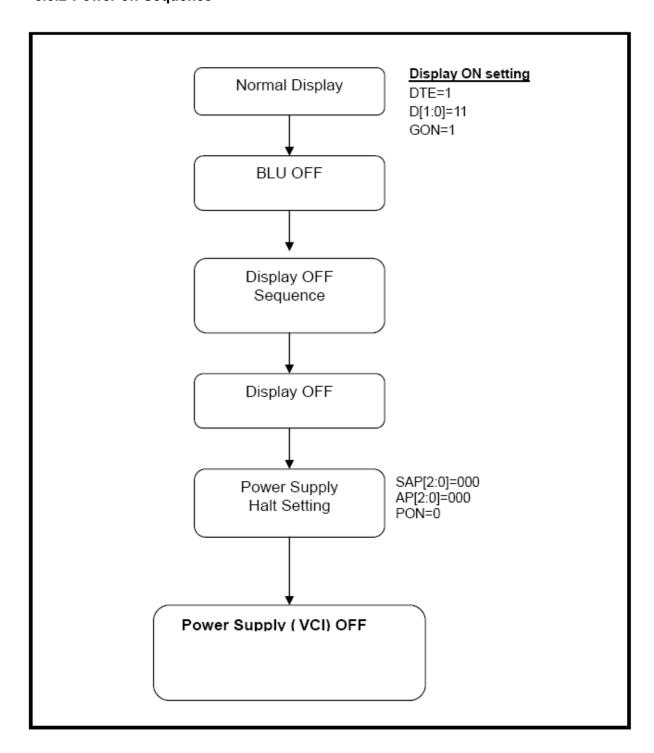
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#### 5.5 Power On/Off sequence 5.5.1 Power on Sequence



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#### 5.5.2 Power off Sequence





### 6 Optical Characteristics

Ta=25°C

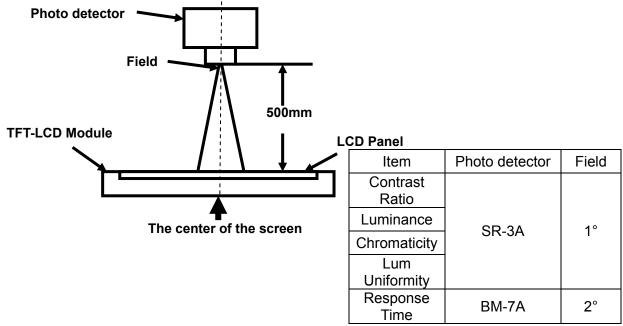
Item	ı	Symbol	Condition	Min	Тур	Max	Unit	Remark
		θТ		45	50	-		
Minus Amalan		θВ	CR≧10	15	20	-	Dograo	Note 2
View Angles		θL	CK=10	40	45	-	Degree	Note 2
		θR		40	45	-		
Contrast Ratio	1	CR	θ=0°	200	350	-	-	Note1 Note3
Response Tim	e	T <sub>ON</sub>	25℃	-	30	40	ms	Note1 Note4
	1	T <sub>OFF</sub>		0.000	0.000	0.000		NOIC4
	White	Х		0.238	0.288	0.338		Note5 Note1
		У	Backlight is on	0.258	0.308	0.358		
	Red	Х		0.554	0.604	0.654		
Chromaticity		У		0.295	0.345	0.395		
	Green	Х		0.284	0.334	0.384		
	Orceri	у		0.450	0.500	0.550		
	Blue	х		0.095	0.144	0.194		
	Diue	У		0.061	0.111	0.161		
Uniformity		U	-	70	80	-	%	Note1 Note6
NTSC		-	-	-	40	-	%	Note 5
Luminance		L		200	250	-	cd/m <sup>2</sup>	Note1 Note7

#### **Test Conditions:**

- 1.  $V_F=3.2V$ ,  $I_F=15mA$ (One LED current), the ambient temperature is  $25^{\circ}C$ .
- 2. The test systems refer to Note 1 and Note 2.

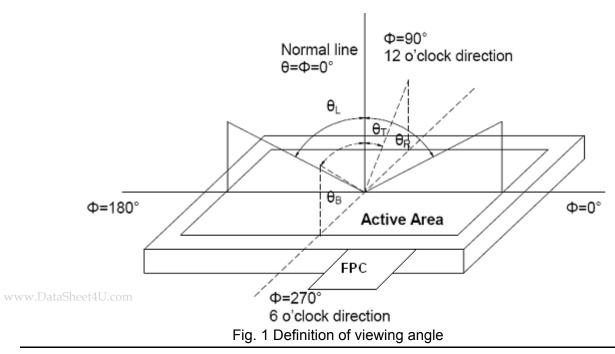
Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).





Note 3: Definition of contrast ratio

Contrast ratio (CR) =  $\frac{\text{Luminance measured when LCD is on the "White" state}}{\text{Luminance measured when LCD is on the "Black" state}}$ 

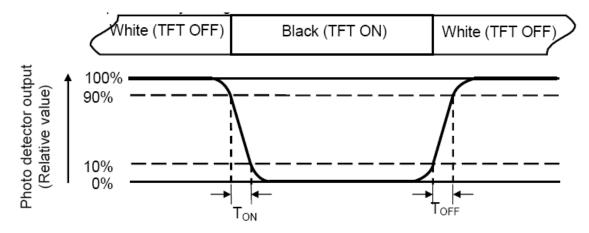
"White state ": The state is that the LCD should driven by Vwhite.

"Black state": The state is that the LCD should driven by Vblack.

Vwhite: To be determined Vblack: To be determined.

#### Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.



### Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity(U) = Lmin/Lmax

L-----Active area length W----- Active area width

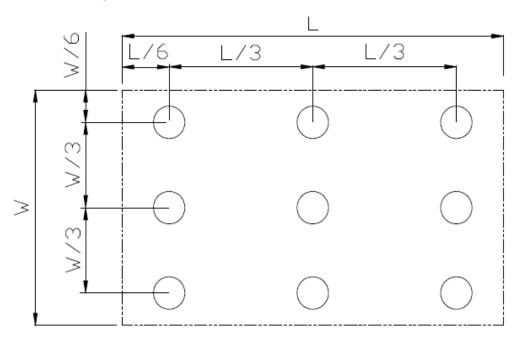


Fig. 2 Definition of uniformity

Lmax: The measured maximum luminance of all measurement position.

Lmin: The measured minimum luminance of all measurement position.

#### Note 7: Definition of Luminance:

Measure the luminance of white state at center point.



## 7 Environmental / Reliability Test

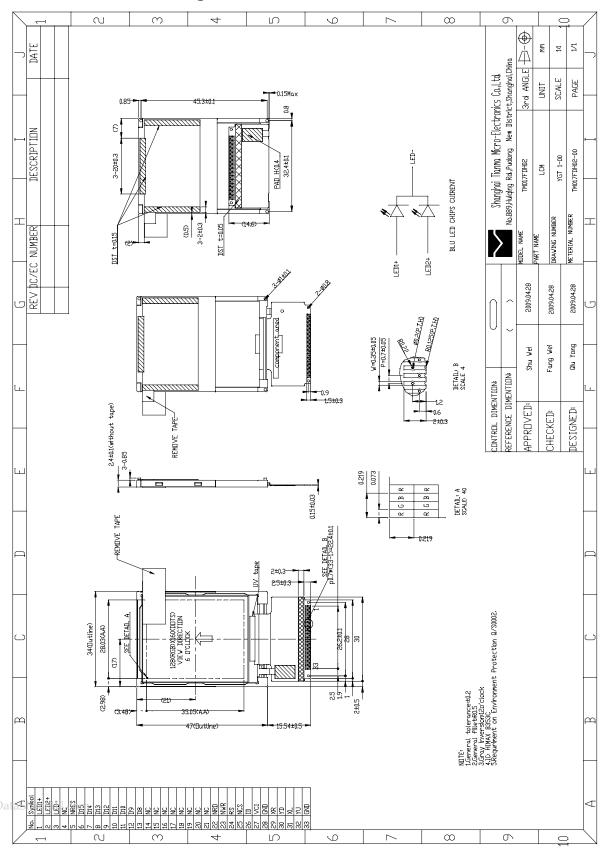
No	Test Item	Condition	Remark	
1	High Temperature Operation	Ts=+70℃, 240hrs	Note1 IEC60068-2-2,GB2423.2—89	
	Low Temperature Operation		IEC60068-2-1 GB2423.1—89	
	High Temperature Storage		IEC60068-2-2, GB2423.2—89	
4	Low Temperature Storage	Ta=-30℃, 240hrs	IEC60068-2-1 GB2423.1—89	
5	High Temperature & High Humidity Storage	Ta=+60℃, 90% RH 240 hours	Note2 IEC60068-2-3, GB/T2423.3—2006	
6	Thermal Shock (Non-operation)	-30°C 30 min~+70°C 30 min, Change time:5min, 20 Cycles	Start with cold temperature, End with high temperature, IEC60068-2-14,GB2423.22—87	
7	Electro Static Discharge (Operation)	C=150pF, R=330 $\Omega$ ,5points/panel Air:± 8KV, 5times, Contact:± 4KV, 5 times, (Environment: 15 $^{\circ}$ C $^{\circ}$ 35 $^{\circ}$ C, 30% $^{\circ}$ 60%, 86Kpa $^{\circ}$ 106Kpa)	IEC61000-4-2 GB/T17626.2—1998	
8	Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total)(Package condition)	IEC60068-2-6 GB/T2423.10—1995	
9	Shock (Non-operation)	60G 6ms, ± X,± Y,± Z 3times, for each direction	IEC60068-2-27 GB/T2423.5—1995	
10	Package Drop Test	Height:80 cm, 1 corner, 3 edges, 6 surfaces	IEC60068-2-32 GB/T2423.8—1995	

Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of sample.



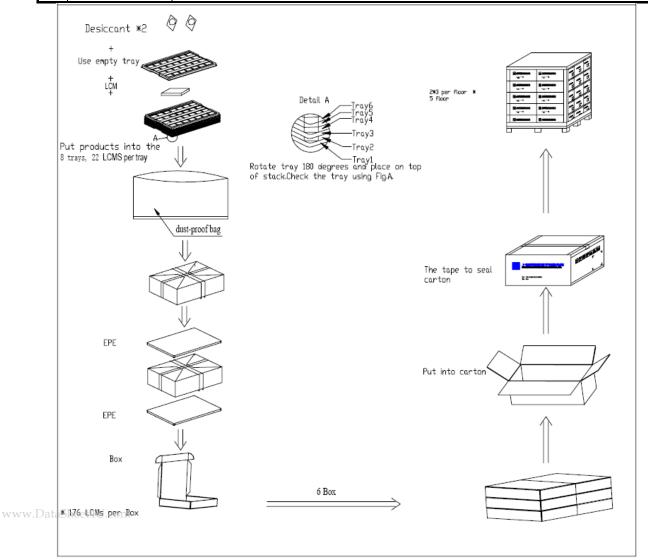
### 8 Mechanical Drawing





# 9 Packing Drawing

No	Item	Model (Material)	Dimensions(mm)	Unit Weight(Kg)	Quantity	Remark
1	LCM module	TM017FDH02	34x47x2.4	0.0062	1056	
2	Tray	PET(Transmit)	315×247×10.8	0.0845	54	Anti-static
3	EPE	EPE	315×247×5	0.009	12	
4	Anti-static bag	PE	327×440	0.021	6	
5	BOX	Corrugated Paper	345×260×70	0.227	6	
6	Desiccant	Desiccant	45x50	0.0035	12	
7	Carton	Corrugated Paper	544×365×250	1.01	1	
8	Total weight(Kg)		13.75	1		





#### 10 Precautions For Use of LCD Modules

- 10.1 Handling Precautions
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
  - Isopropyl alcohol
  - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - 10.1.8.1 Be sure to ground the body when handling the LCD Modules.
  - 10.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.
  - 10.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
  - 10.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.
    - 10.2 Storage precautions
- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature :  $0^{\circ}$   $\sim$  40  $^{\circ}$  Relatively humidity: ≤80%

- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 Transportation Precautions

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.